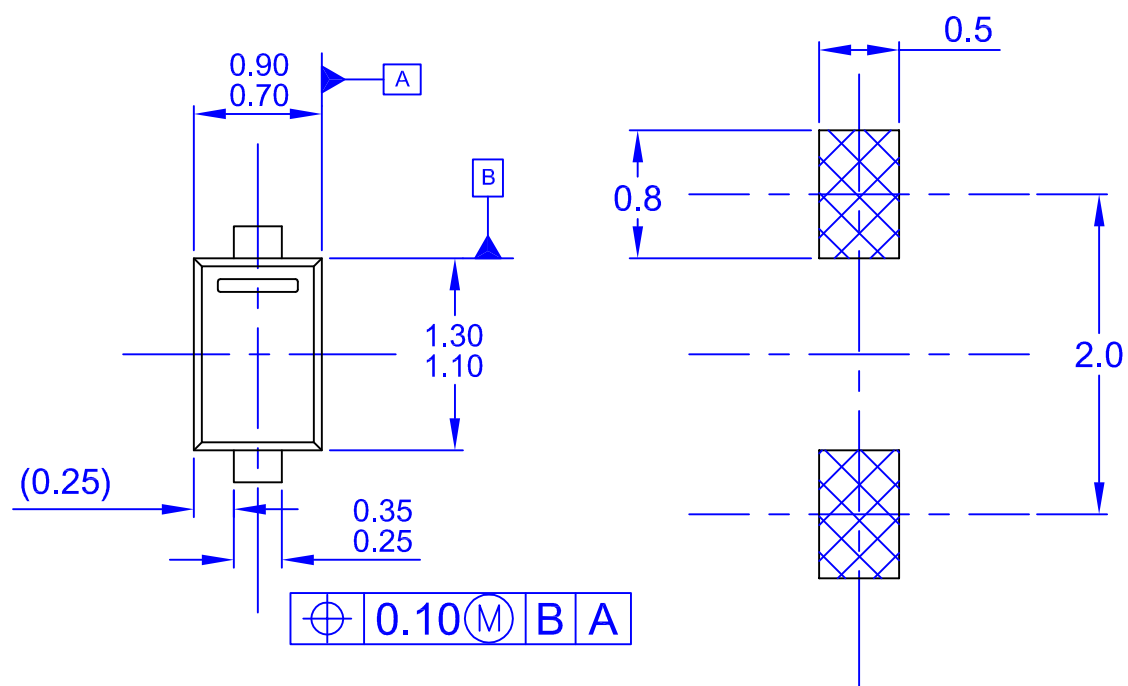
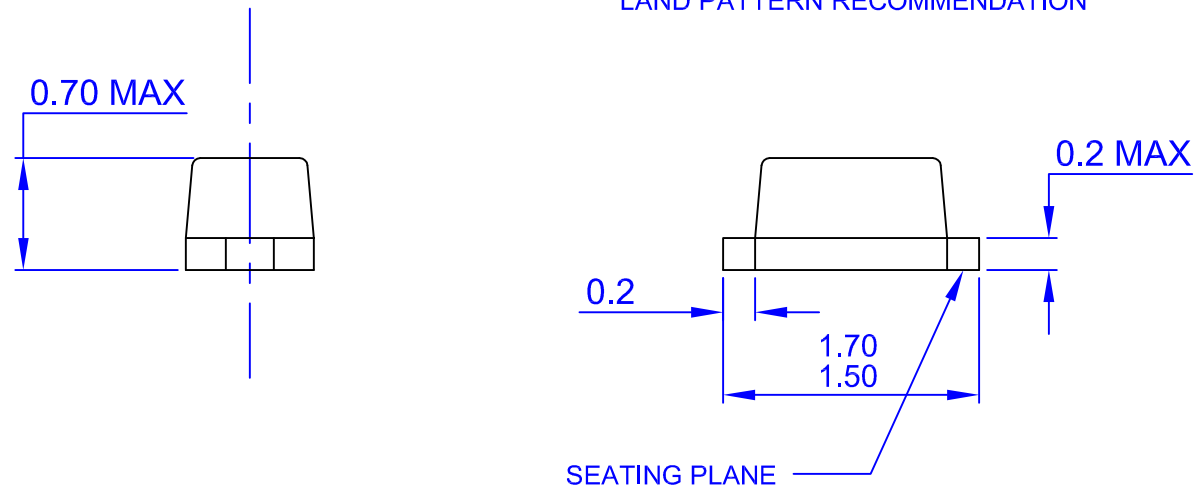


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REVISIONS			
LTR	DESCRIPTION	DATE	BY/SITE
1	RELEASE TO DOCUMENT CONTROL	19DEC2007	S.D. LEE/SUIZHOU



LAND PATTERN RECOMMENDATION



- NOTES: UNLESS OTHERWISE SPECIFIED
- A) PACKAGE REFERENCE: THIS PACKAGE OUTLINE CONFORMS TO JEITA SC-79.
  - B) ALL DIMENSIONS ARE IN MILLIMETERS.
  - C) DRAWING CONFORMS TO ASME Y14.5M - 1994
  - D) DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
  - E) LANDPATTERN RECOMMENDATION IS BASED ON IPC7351A STANDARD SOD1609X65M.
  - F) DRAWING NUMBER AND REVISION: MKT-SOD523F1rev1

APPROVALS	DATE			
DRAWN: CHRISTOPHER DAI	19DEC2007			
CHECKED: BOBOY MALDO				
APPROVED: SILNORE SABANDO				
S.D. LEE		2LD, SOD523F, JEITA SC 79, 0.7MM, TALL		
PROJECTION	SCALE	SIZE	DRAWING NUMBER	REV
	1:1	A3	MKT-SOD523F1	1
INCH END	FORMERLY: N/A	SHEET : 1 OF 1		